

**Final datasheet**

**EasyPACK™ 2B module with TRENCHSTOP™ 5 H5 and CoolSiC™ Schottky diode and PressFIT / NTC**

**Features**

- Electrical features
  - $V_{CES} = 650\text{ V}$
  - $I_{C\text{ nom}} = 40\text{ A} / I_{CRM} = 80\text{ A}$
  - CoolSiC™ Schottky diode gen 5
  - Low switching losses
  - Increased blocking voltage capability up to 650 V
  - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
  - Rugged mounting due to integrated mounting clamps
  - AlN substrate with low thermal resistance
  - Compact design
  - PressFIT contact technology



Typical appearance

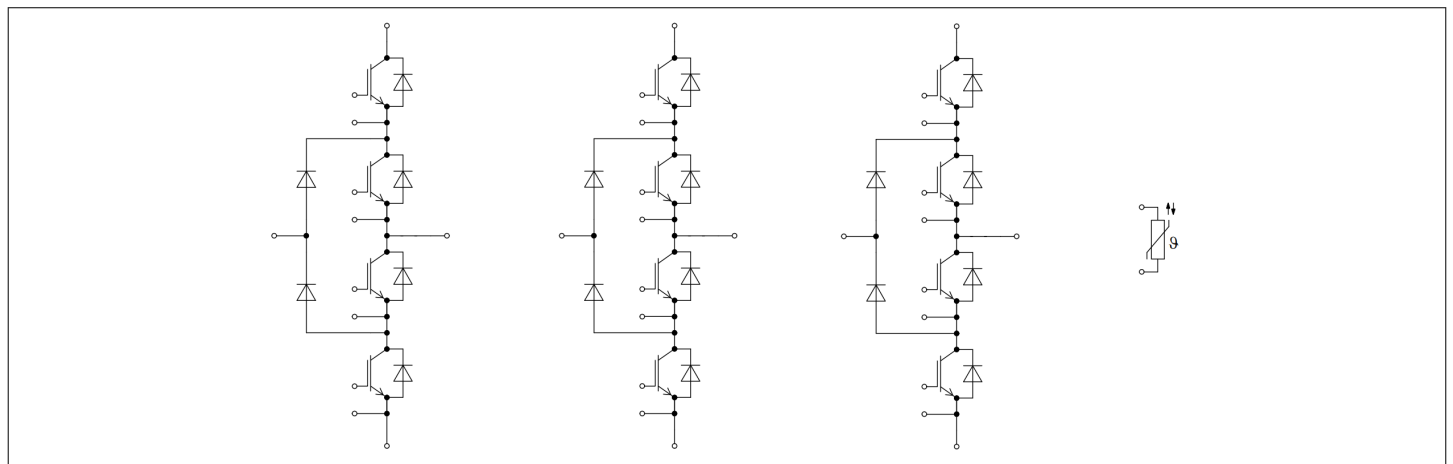
**Potential applications**

- Three-level applications
- UPS systems
- Solar applications
- Motor drives

**Product validation**

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

**Description**



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## 1 Package

**Table 1** Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	$V_{ISOL}$	RMS, $f = 50$ Hz, $t = 60$ s	3.0	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50$ Hz, $t = 60$ s	3.0	kV
Internal isolation		basic insulation (class 1, IEC 61140)	AIN	
Comparative tracking index	$CTI$		> 200	
Relative thermal index (electrical)	$RTI$	housing	140	°C

**Table 2** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	$L_{SCE}$			36		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H = 25$ °C, per switch		8.2		mΩ
Storage temperature	$T_{stg}$		-40		125	°C
Mounting force per clamp	$F$		40		80	N
Weight	$G$			42		g

**Note:** The current under continuous operation is limited to 25A rms per connector pin

## 2 IGBT, Inverter

**Table 3** Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	$V_{CES}$		$T_{vj} = 25$ °C	650	V
Implemented collector current	$I_{CN}$			40	A
Continuous DC collector current	$I_{CDC}$	$T_{vj\ max} = 175$ °C	$T_H = 115$ °C	20	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{vj\ op}$		80	A
Gate-emitter peak voltage	$V_{GES}$			±20	V

**Table 4** Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 20\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.32	1.81	V
			$T_{vj} = 125\ ^\circ C$		1.39		
			$T_{vj} = 150\ ^\circ C$		1.41		
Gate threshold voltage	$V_{GETh}$	$I_C = 0.35\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		3.85	4.60	5.35	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\ V, V_{CC} = 300\ V$			0.152		$\mu C$
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\ ^\circ C$			0		$\Omega$
Input capacitance	$C_{ies}$	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			1.94		nF
Reverse transfer capacitance	$C_{res}$	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.007		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 650\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			0.018	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 20\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 7.5\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.011		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.012		
			$T_{vj} = 150\ ^\circ C$		0.012		
Rise time (inductive load)	$t_r$	$I_C = 20\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 7.5\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.009		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.014		
			$T_{vj} = 150\ ^\circ C$		0.015		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 20\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 7.5\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.078		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.099		
			$T_{vj} = 150\ ^\circ C$		0.105		
Fall time (inductive load)	$t_f$	$I_C = 20\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 7.5\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.018		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.029		
			$T_{vj} = 150\ ^\circ C$		0.046		
Turn-on energy loss per pulse	$E_{on}$	$I_C = 20\ A, V_{CC} = 300\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 7.5\ \Omega, di/dt = 1100\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		0.17		mJ
			$T_{vj} = 125\ ^\circ C$		0.2		
			$T_{vj} = 150\ ^\circ C$		0.21		
Turn-off energy loss per pulse	$E_{off}$	$I_C = 20\ A, V_{CC} = 300\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 7.5\ \Omega, dv/dt = 6250\ V/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		0.1		mJ
			$T_{vj} = 125\ ^\circ C$		0.2		
			$T_{vj} = 150\ ^\circ C$		0.22		
Thermal resistance, junction to heat sink	$R_{thJH}$	per IGBT, $\lambda_{grease} = 1\ W/(m \cdot K)$			1.36		K/W

**(table continues...)**

**Table 4 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

### 3 Diode, Inverter

**Table 5 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} = 25\ ^\circ\text{C}$	650	V	
Implemented forward current	$I_{FN}$		25	A	
Continuous DC forward current	$I_F$		20	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1\ \text{ms}$	50	A	
$I^2t$ - value	$I^2t$	$t_p = 10\ \text{ms}, V_R = 0\ \text{V}$	$T_{vj} = 125\ ^\circ\text{C}$	55	A <sup>2</sup> s
			$T_{vj} = 150\ ^\circ\text{C}$	50	

**Table 6 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	$V_F$	$I_F = 20\ \text{A}, V_{GE} = 0\ \text{V}$	$T_{vj} = 25\ ^\circ\text{C}$		1.65	2.15	V
			$T_{vj} = 125\ ^\circ\text{C}$		1.55		
			$T_{vj} = 150\ ^\circ\text{C}$		1.50		
Peak reverse recovery current	$I_{RM}$	$V_{CC} = 300\ \text{V}, I_F = 20\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 1100\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$		14		A
			$T_{vj} = 125\ ^\circ\text{C}$		18		
			$T_{vj} = 150\ ^\circ\text{C}$		20		
Recovered charge	$Q_r$	$V_{CC} = 300\ \text{V}, I_F = 20\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 1100\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$		0.77		$\mu\text{C}$
			$T_{vj} = 125\ ^\circ\text{C}$		1.2		
			$T_{vj} = 150\ ^\circ\text{C}$		1.44		
Reverse recovery energy	$E_{rec}$	$V_{CC} = 300\ \text{V}, I_F = 20\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 1100\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$		0.16		mJ
			$T_{vj} = 125\ ^\circ\text{C}$		0.22		
			$T_{vj} = 150\ ^\circ\text{C}$		0.27		
Thermal resistance, junction to heat sink	$R_{thJH}$	per diode, $\lambda_{grease} = 1\ \text{W}/(\text{m}\cdot\text{K})$		1.78		K/W	

**(table continues...)**

**Table 6 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

## 4 IGBT, 3-Level

**Table 7 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj} = 25\ ^\circ\text{C}$	650	V
Implemented collector current	$I_{CN}$		40	A
Continuous DC collector current	$I_{CDC}$	$T_{vj\ max} = 175\ ^\circ\text{C}$ $T_H = 115\ ^\circ\text{C}$	20	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{vj\ op}$	80	A
Gate-emitter peak voltage	$V_{GES}$		±20	V

**Table 8 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 20\ \text{A}, V_{GE} = 15\ \text{V}$	$T_{vj} = 25\ ^\circ\text{C}$	1.32	1.81	V
			$T_{vj} = 125\ ^\circ\text{C}$	1.39		
			$T_{vj} = 150\ ^\circ\text{C}$	1.41		
Gate threshold voltage	$V_{GEth}$	$I_C = 0.35\ \text{mA}, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ\text{C}$	3.85	4.60	5.35	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\ \text{V}, V_{CC} = 300\ \text{V}$		0.152		μC
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\ ^\circ\text{C}$		0		Ω
Input capacitance	$C_{ies}$	$f = 100\ \text{kHz}, T_{vj} = 25\ ^\circ\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$		1.94		nF
Reverse transfer capacitance	$C_{res}$	$f = 100\ \text{kHz}, T_{vj} = 25\ ^\circ\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$		0.007		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 650\ \text{V}, V_{GE} = 0\ \text{V}$ $T_{vj} = 25\ ^\circ\text{C}$			0.018	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\ \text{V}, V_{GE} = 20\ \text{V}, T_{vj} = 25\ ^\circ\text{C}$			100	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 20\ \text{A}, V_{CC} = 300\ \text{V}, V_{GE} = \pm 15\ \text{V}, R_{Gon} = 3.9\ \Omega$	$T_{vj} = 25\ ^\circ\text{C}$	0.011		μs
			$T_{vj} = 125\ ^\circ\text{C}$	0.012		
			$T_{vj} = 150\ ^\circ\text{C}$	0.012		

(table continues...)

**Table 8 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rise time (inductive load)	$t_r$	$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 3.9\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.005		$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.006		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.006		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 3.9\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.069		$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.085		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.091		
Fall time (inductive load)	$t_f$	$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 3.9\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.021		$\mu\text{s}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.052		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.065		
Turn-on energy loss per pulse	$E_{on}$	$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, L_\sigma = 35\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 3.9\ \Omega, di/dt = 3500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.08		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.09		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.09		
Turn-off energy loss per pulse	$E_{off}$	$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, L_\sigma = 35\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 3.9\ \Omega, dv/dt = 6210\text{ V}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	0.11		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	0.19		
			$T_{vj} = 150\text{ }^\circ\text{C}$	0.21		
Thermal resistance, junction to heat sink	$R_{thJH}$	per IGBT, $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$		1.36		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		150	$^\circ\text{C}$

## 5 Diode, 3-Level

**Table 9 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} = 25\text{ }^\circ\text{C}$	650	V	
Continuous DC forward current	$I_F$		20	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1\text{ ms}$	40	A	
$I^2t$ - value	$I^2t$	$t_p = 10\text{ ms}, V_R = 0\text{ V}$	$T_{vj} = 125\text{ }^\circ\text{C}$	65	$\text{A}^2\text{s}$
			$T_{vj} = 150\text{ }^\circ\text{C}$	65	

**Table 10** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	$V_F$	$I_F = 20 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		1.45	1.85	V
			$T_{vj} = 125 \text{ °C}$		1.60		
			$T_{vj} = 150 \text{ °C}$		1.65		
Peak reverse recovery current	$I_{RM}$	$V_{CC} = 300 \text{ V}, I_F = 20 \text{ A}, V_{GE} = 15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		19		A
			$T_{vj} = 125 \text{ °C}$		17		
			$T_{vj} = 150 \text{ °C}$		16		
Recovered charge	$Q_r$	$V_{CC} = 300 \text{ V}, I_F = 20 \text{ A}, V_{GE} = 15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		0.13		$\mu\text{C}$
			$T_{vj} = 125 \text{ °C}$		0.12		
			$T_{vj} = 150 \text{ °C}$		0.12		
Reverse recovery energy	$E_{rec}$	$V_{CC} = 300 \text{ V}, I_F = 20 \text{ A}, V_{GE} = 15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		0.015		mJ
			$T_{vj} = 125 \text{ °C}$		0.015		
			$T_{vj} = 150 \text{ °C}$		0.015		
Thermal resistance, junction to heat sink	$R_{thJH}$	per diode, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$			1.92		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$			-40		150	°C

## 6 NTC-Thermistor

**Table 11** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$R_{25}$	$T_{NTC} = 25 \text{ °C}$		5		k $\Omega$
Deviation of $R_{100}$	$\Delta R/R$	$T_{NTC} = 100 \text{ °C}, R_{100} = 493 \text{ }\Omega$	-5		5	%
Power dissipation	$P_{25}$	$T_{NTC} = 25 \text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

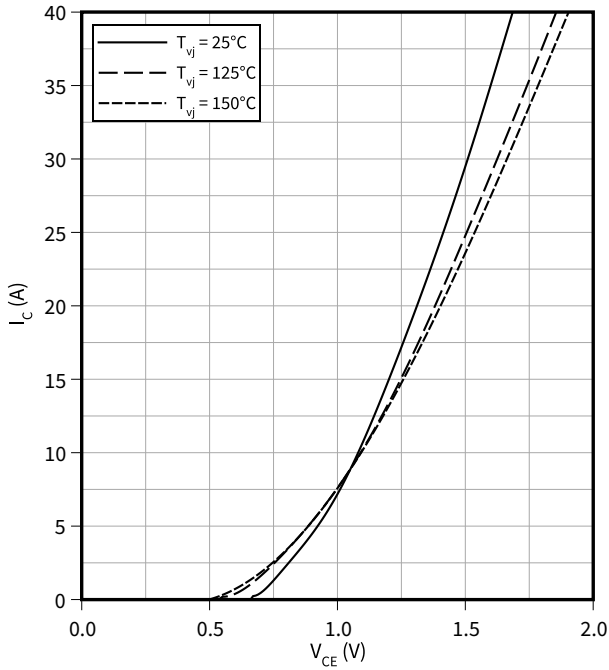
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4.



## 7 Characteristics diagrams

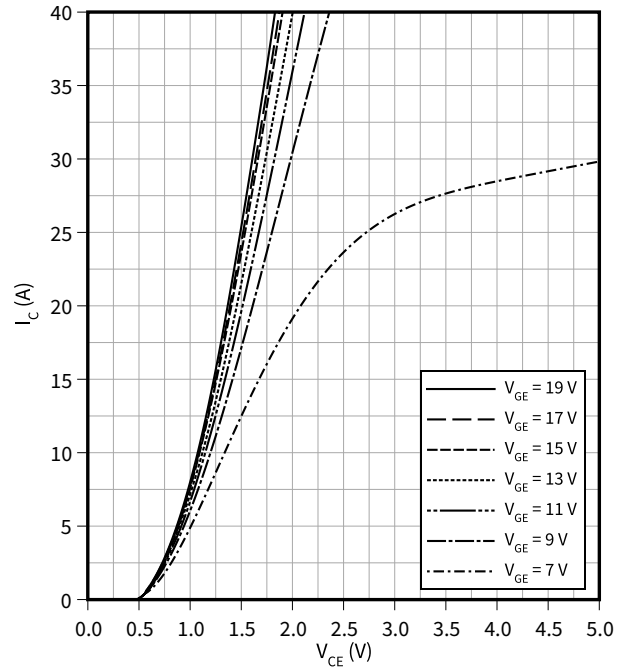
**Output characteristic (typical), IGBT, Inverter**

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



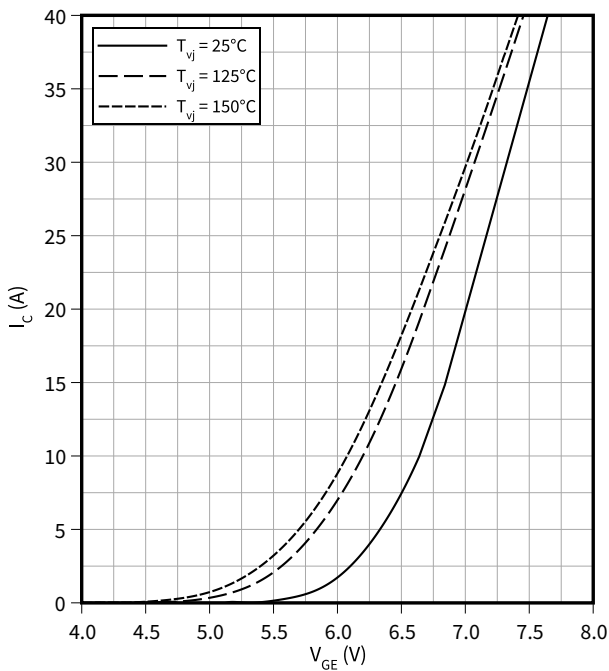
**Output characteristic field (typical), IGBT, Inverter**

$I_C = f(V_{CE})$   
 $T_{vj} = 150\text{ °C}$



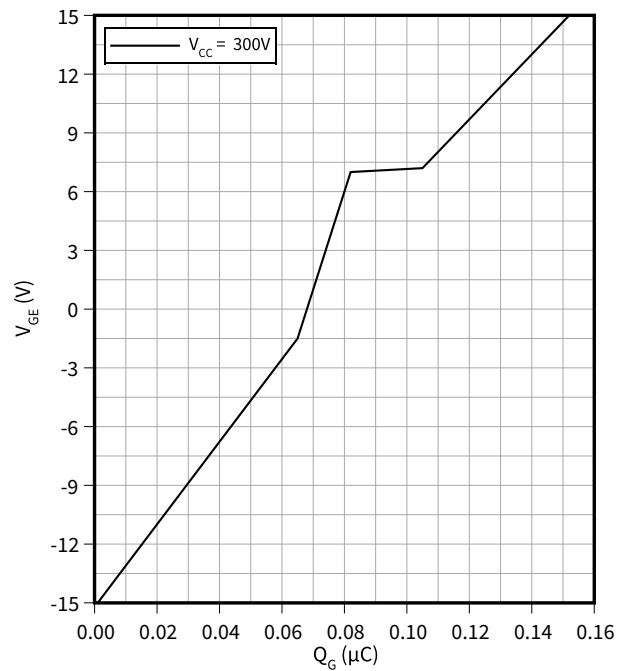
**Transfer characteristic (typical), IGBT, Inverter**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



**Gate charge characteristic (typical), IGBT, Inverter**

$V_{GE} = f(Q_G)$   
 $I_C = 20\text{ A}, T_{vj} = 25\text{ °C}$

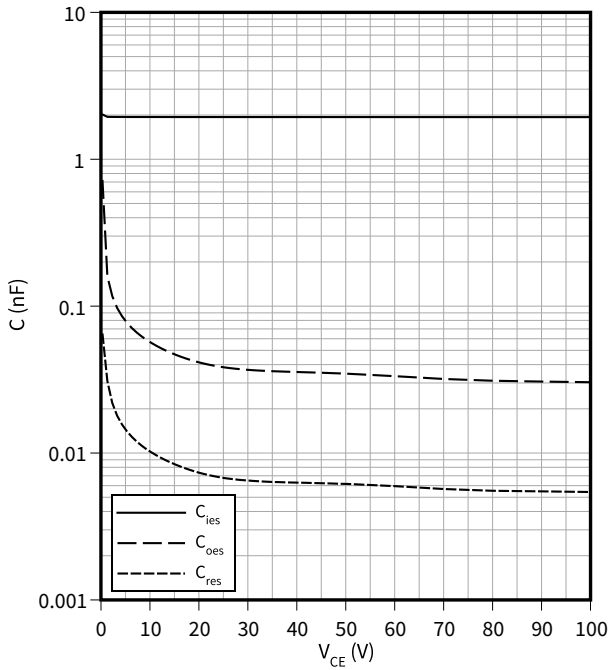


7 Characteristics diagrams

**Capacity characteristic (typical), IGBT, Inverter**

$C = f(V_{CE})$

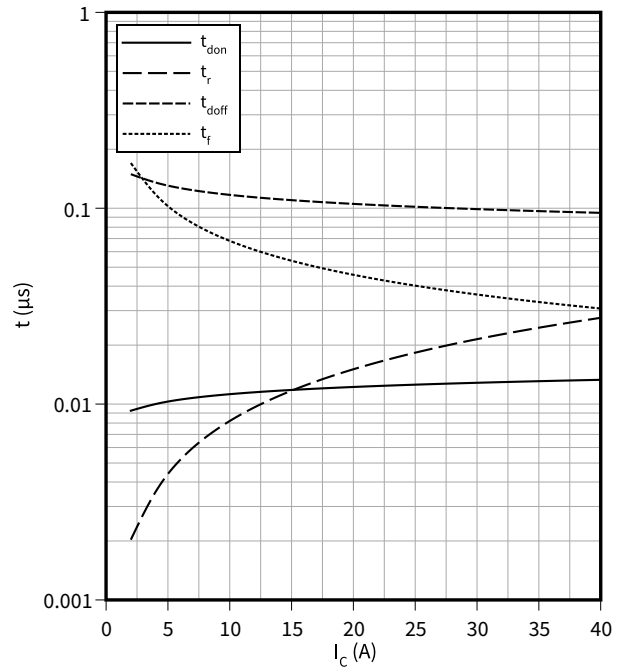
$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$



**Switching times (typical), IGBT, Inverter**

$t = f(I_C)$

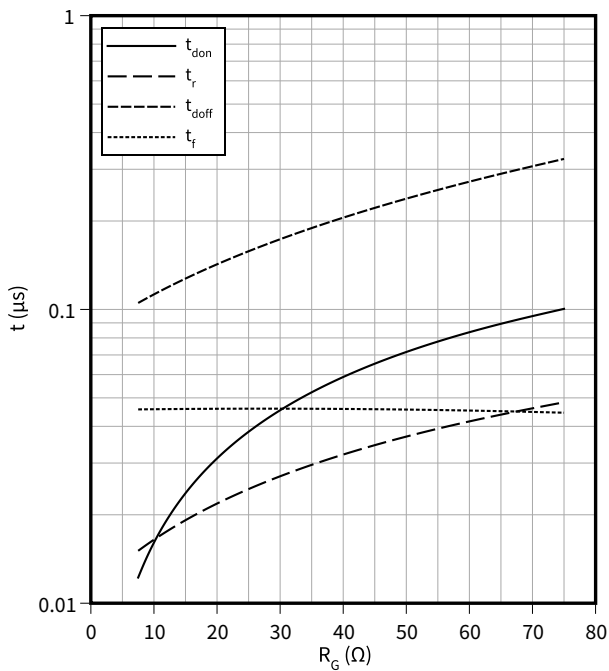
$R_{Goff} = 7.5 \text{ } \Omega, R_{Gon} = 7.5 \text{ } \Omega, V_{CC} = 300 \text{ V}, V_{GE} = -15 / 15 \text{ V}, T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching times (typical), IGBT, Inverter**

$t = f(R_G)$

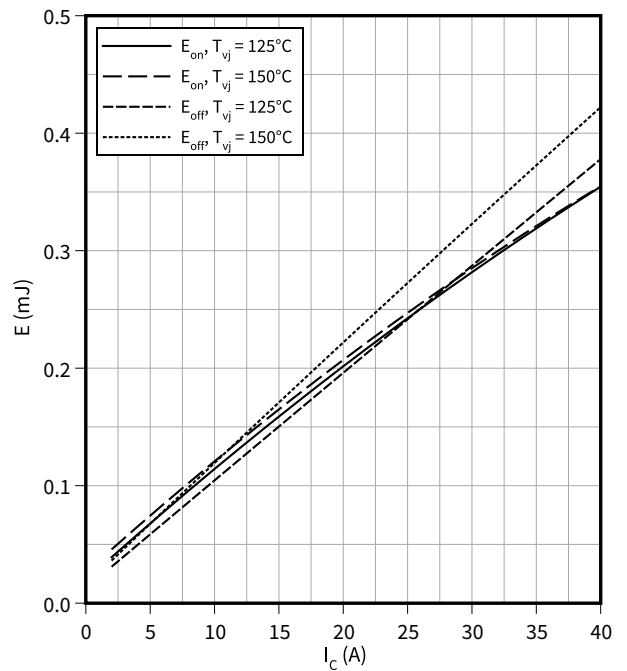
$I_C = 20 \text{ A}, V_{CC} = 300 \text{ V}, V_{GE} = -15 / 15 \text{ V}, T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching losses (typical), IGBT, Inverter**

$E = f(I_C)$

$R_{Goff} = 7.5 \text{ } \Omega, R_{Gon} = 7.5 \text{ } \Omega, V_{CC} = 300 \text{ V}, V_{GE} = -15 / 15 \text{ V}$

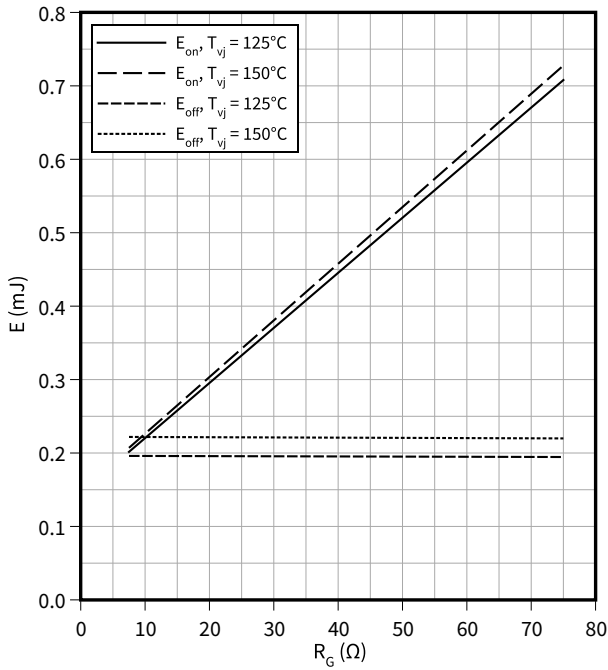


**7 Characteristics diagrams**

**Switching losses (typical), IGBT, Inverter**

$E = f(R_G)$

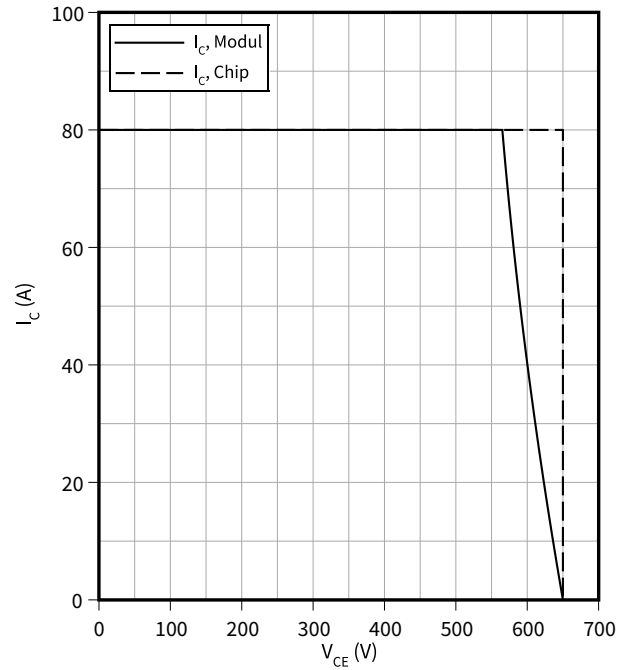
$I_C = 20\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = -15 / 15\text{ V}$



**Reverse bias safe operating area (RBSOA), IGBT, Inverter**

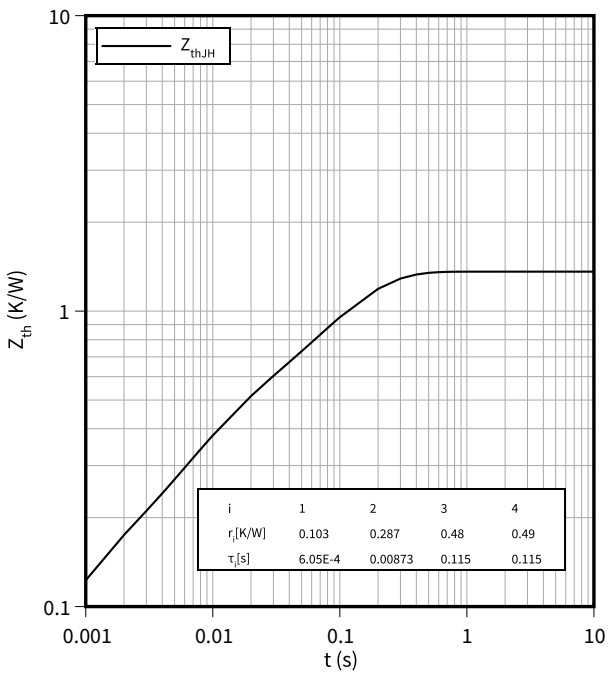
$I_C = f(V_{CE})$

$R_{Goff} = 7.5\ \Omega, V_{GE} = \pm 15\text{ V}, T_{vj} = 150\text{ °C}$



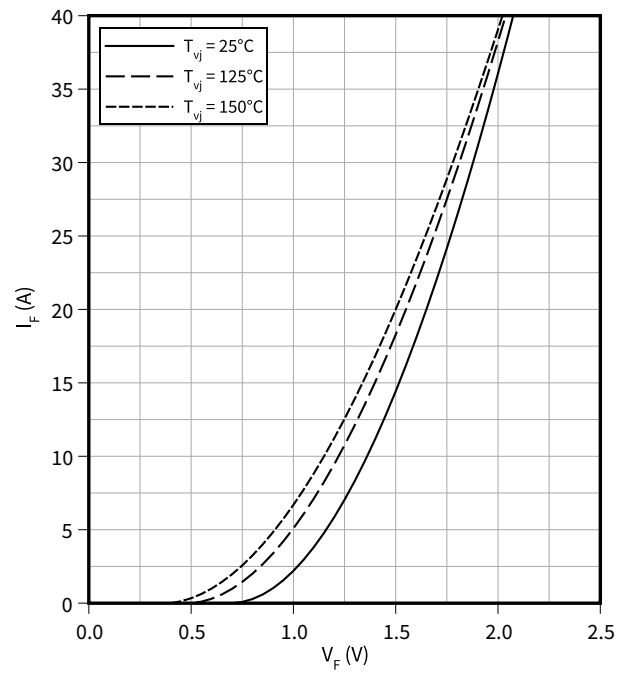
**Transient thermal impedance, IGBT, Inverter**

$Z_{th} = f(t)$



**Forward characteristic (typical), Diode, Inverter**

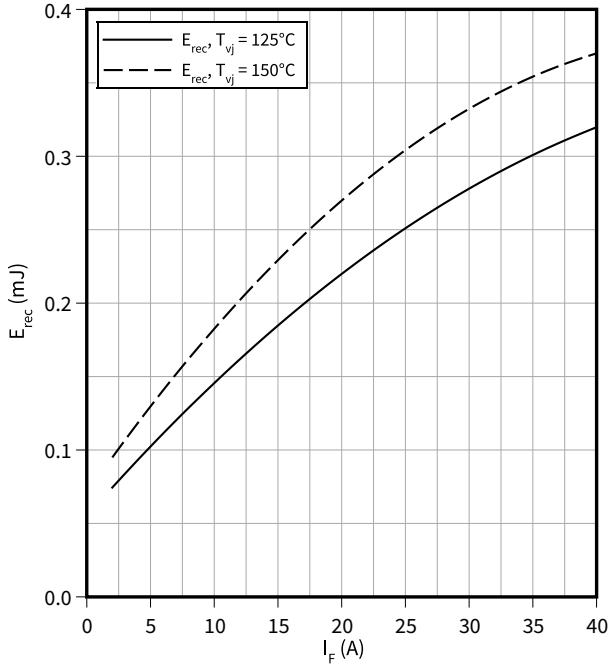
$I_F = f(V_F)$



7 Characteristics diagrams

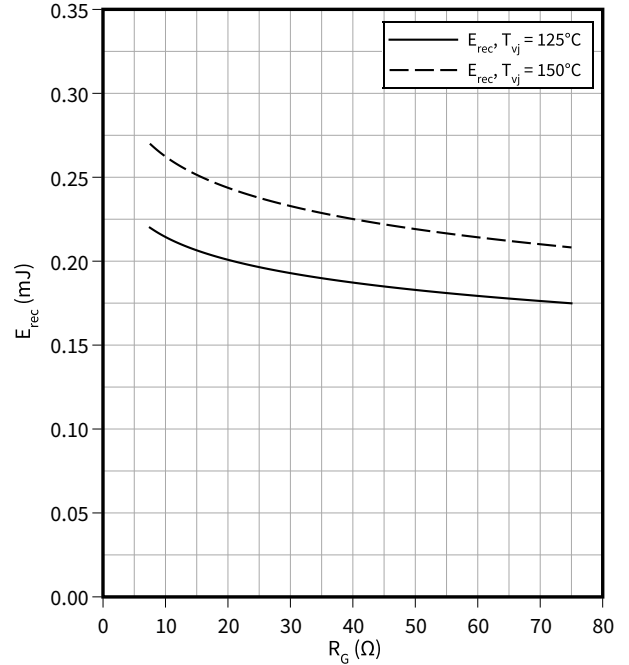
**Switching losses (typical), Diode, Inverter**

$E_{rec} = f(I_F)$   
 $R_{Gon} = 7.5 \Omega, V_{CE} = 300 V$



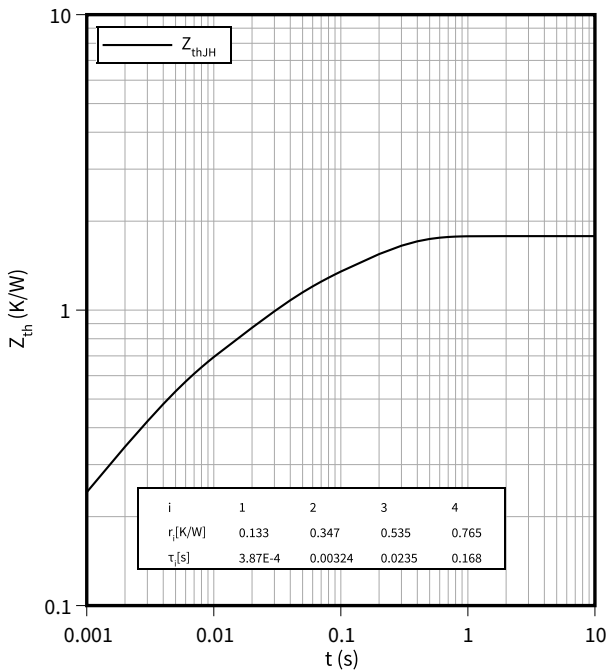
**Switching losses (typical), Diode, Inverter**

$E_{rec} = f(R_G)$   
 $V_{CE} = 300 V, I_F = 20 A$



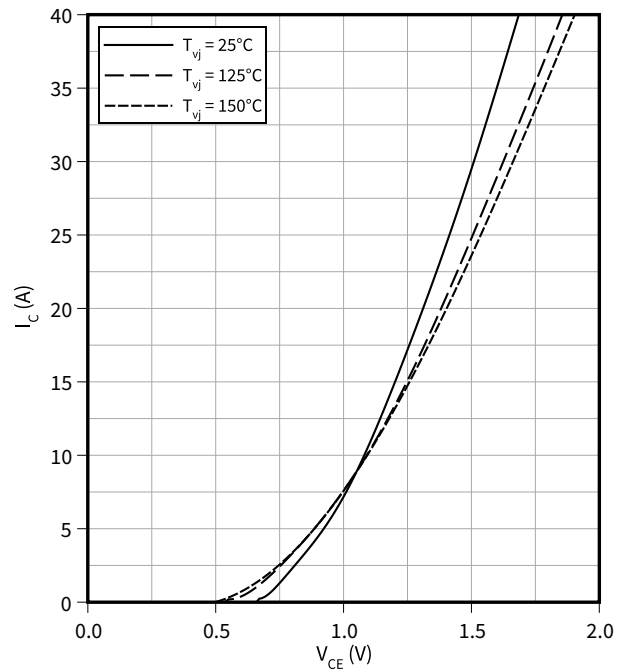
**Transient thermal impedance, Diode, Inverter**

$Z_{th} = f(t)$



**Output characteristic (typical), IGBT, 3-Level**

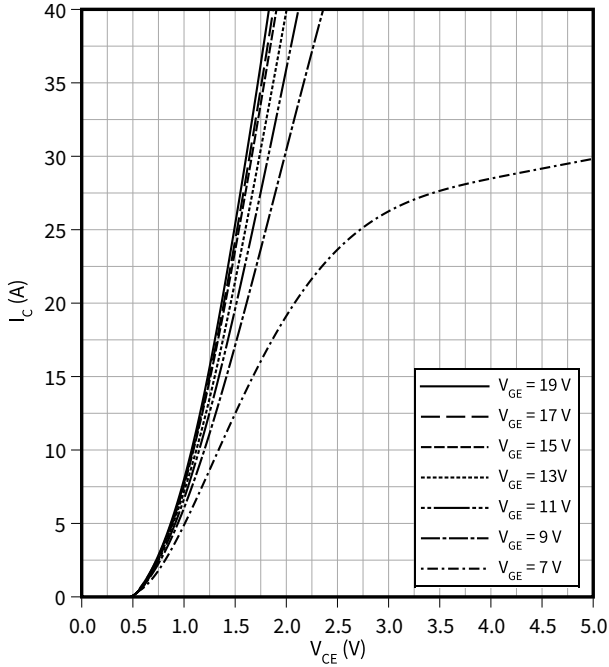
$I_C = f(V_{CE})$   
 $V_{GE} = 15 V$



7 Characteristics diagrams

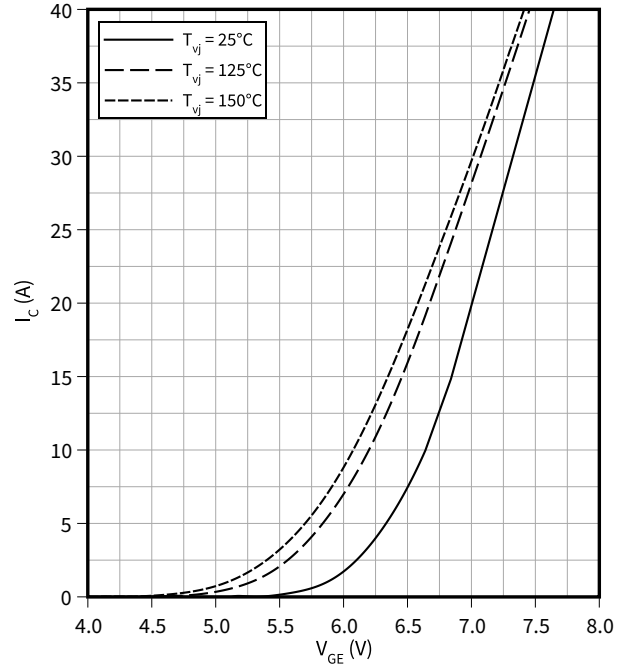
**Output characteristic field (typical), IGBT, 3-Level**

$I_C = f(V_{CE})$   
 $T_{vj} = 150\text{ °C}$



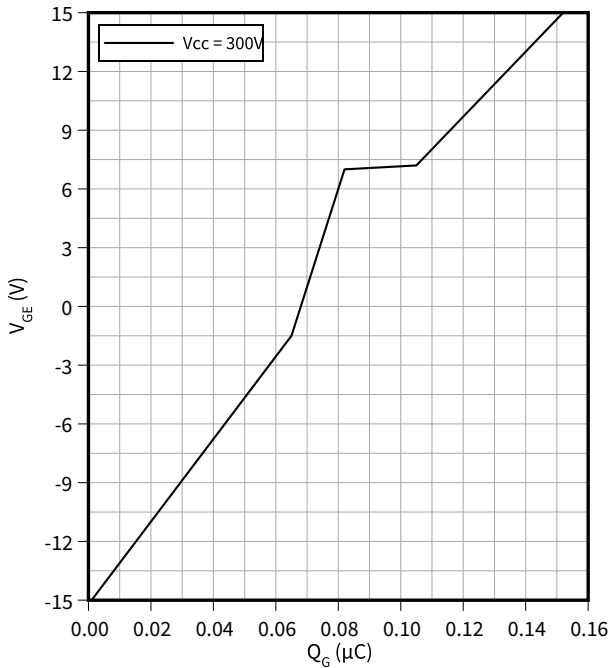
**Transfer characteristic (typical), IGBT, 3-Level**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



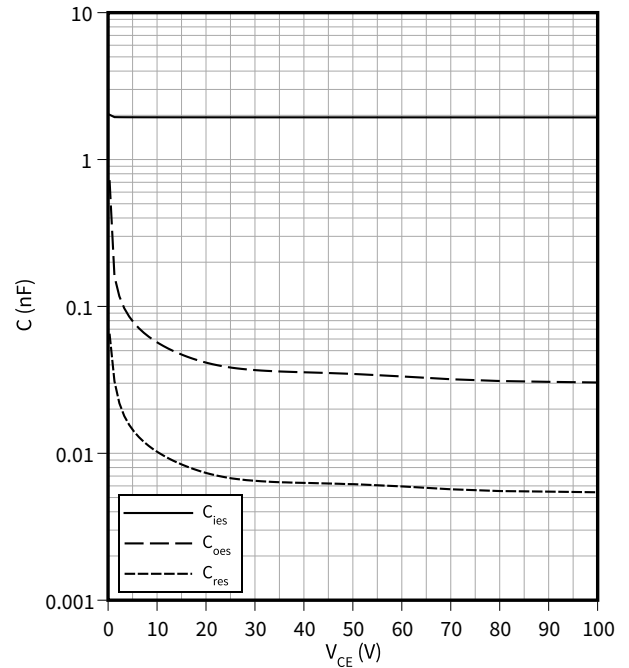
**Gate charge characteristic (typical), IGBT, 3-Level**

$V_{GE} = f(Q_G)$   
 $I_C = 20\text{ A}, T_{vj} = 25\text{ °C}$



**Capacity characteristic (typical), IGBT, 3-Level**

$C = f(V_{CE})$   
 $f = 100\text{ kHz}, V_{GE} = 0\text{ V}, T_{vj} = 25\text{ °C}$

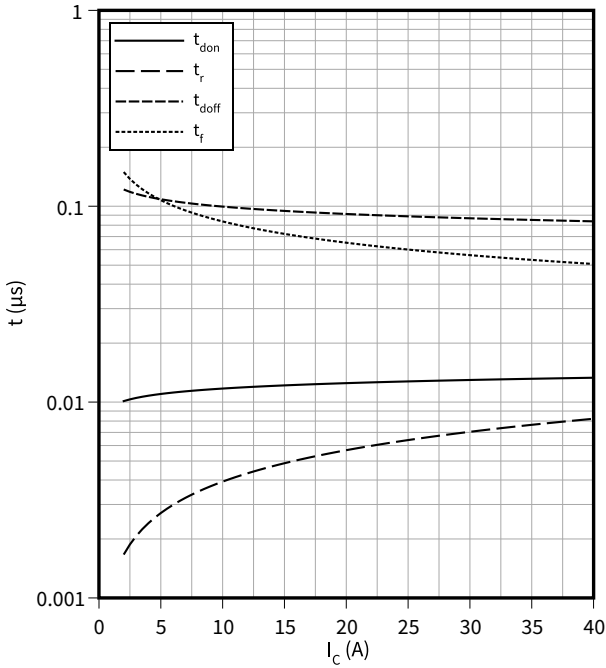


7 Characteristics diagrams

**Switching times (typical), IGBT, 3-Level**

$t = f(I_C)$

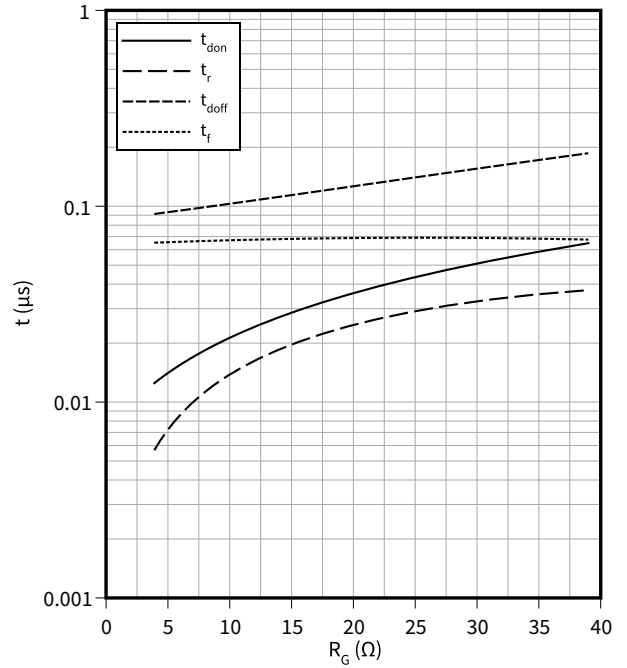
$R_{Goff} = 3.9 \Omega$ ,  $R_{Gon} = 3.9 \Omega$ ,  $V_{CC} = 300 \text{ V}$ ,  $V_{GE} = -15 / 15 \text{ V}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching times (typical), IGBT, 3-Level**

$t = f(R_G)$

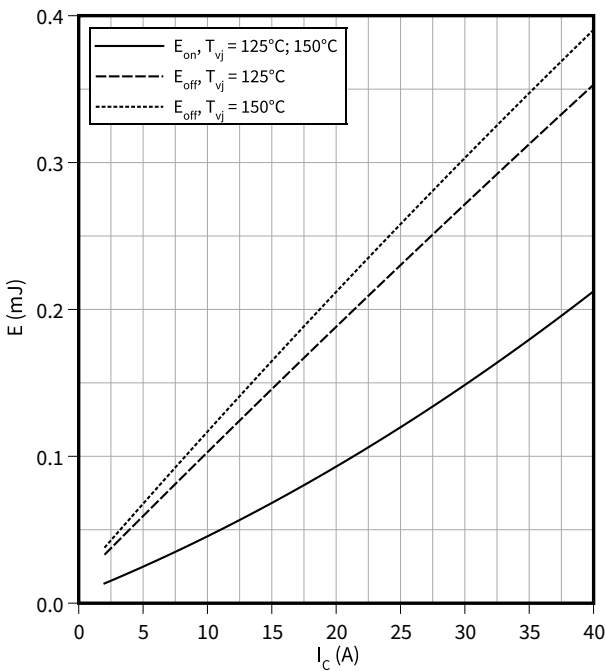
$I_C = 20 \text{ A}$ ,  $V_{CC} = 300 \text{ V}$ ,  $V_{GE} = -15 / 15 \text{ V}$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



**Switching losses (typical), IGBT, 3-Level**

$E = f(I_C)$

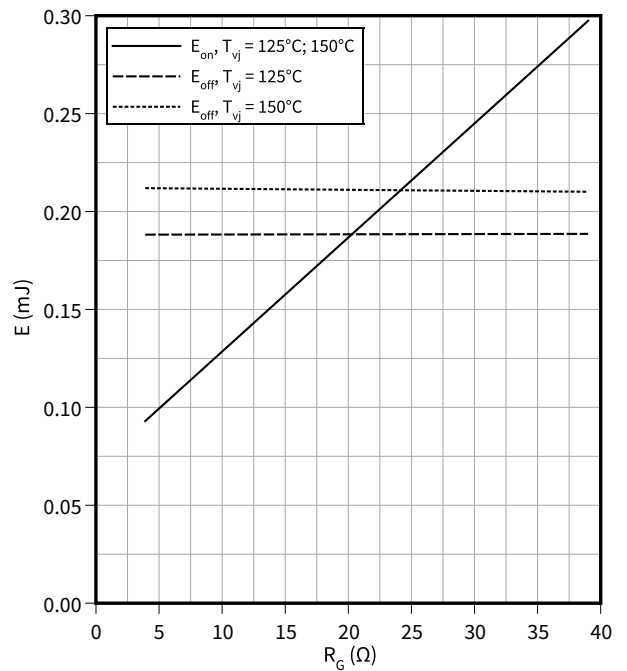
$R_{Goff} = 3.9 \Omega$ ,  $R_{Gon} = 3.9 \Omega$ ,  $V_{CC} = 300 \text{ V}$ ,  $V_{GE} = -15 / 15 \text{ V}$



**Switching losses (typical), IGBT, 3-Level**

$E = f(R_G)$

$I_C = 20 \text{ A}$ ,  $V_{CC} = 300 \text{ V}$ ,  $V_{GE} = -15 / 15 \text{ V}$

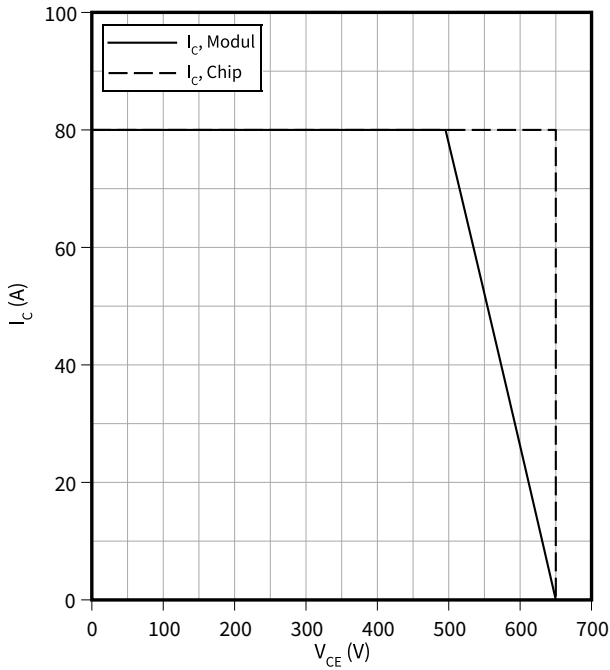


7 Characteristics diagrams

**Reverse bias safe operating area (RBSOA), IGBT, 3-Level**

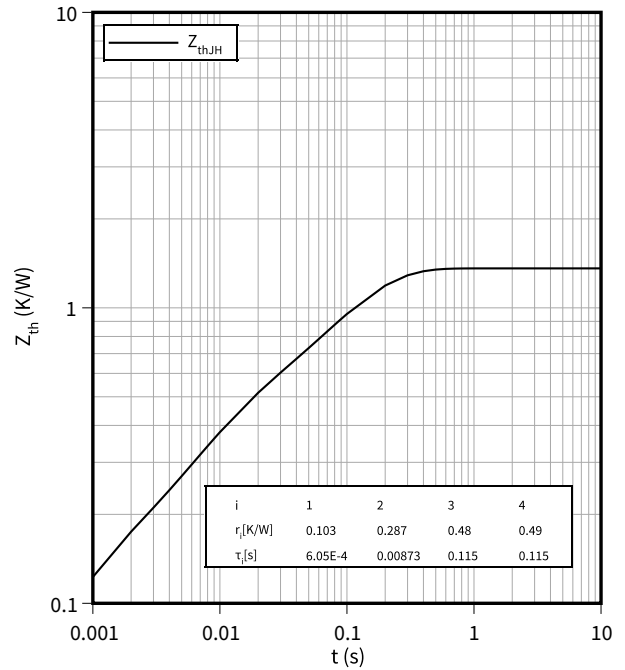
$I_C = f(V_{CE})$

$R_{Goff} = 3.9 \Omega$ ,  $V_{GE} = \pm 15 V$ ,  $T_{vj} = 150 \text{ }^\circ\text{C}$



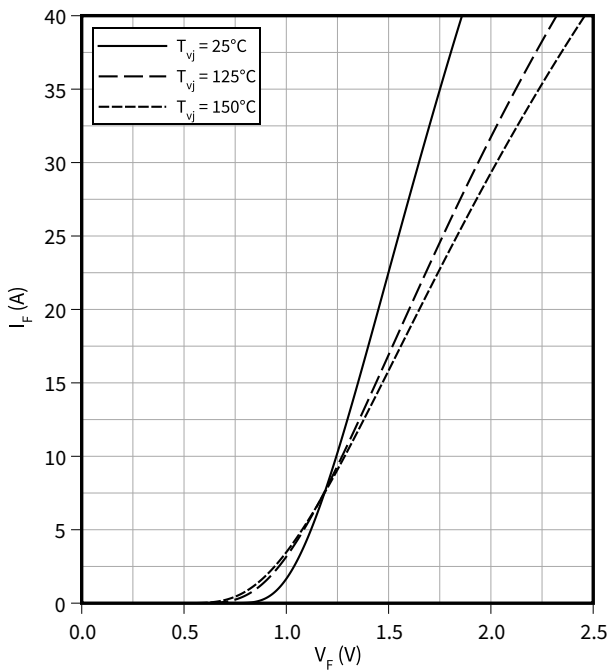
**Transient thermal impedance, IGBT, 3-Level**

$Z_{th} = f(t)$



**Forward characteristic (typical), Diode, 3-Level**

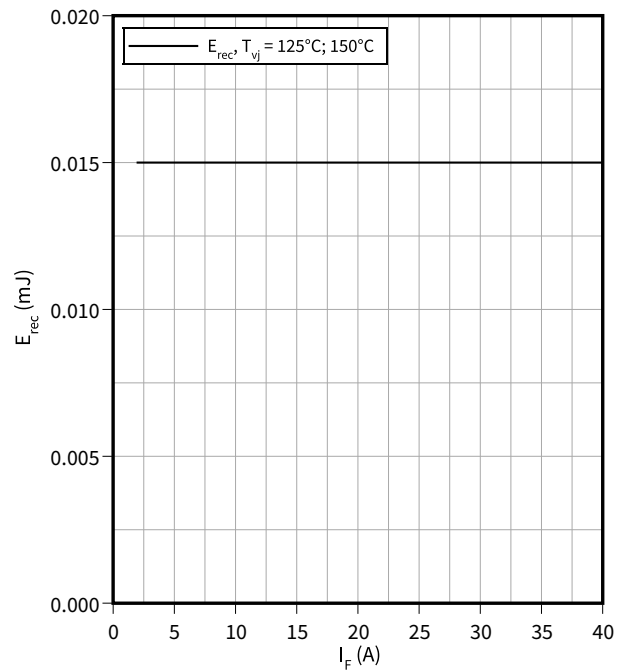
$I_F = f(V_F)$



**Switching losses (typical), Diode, 3-Level**

$E_{rec} = f(I_F)$

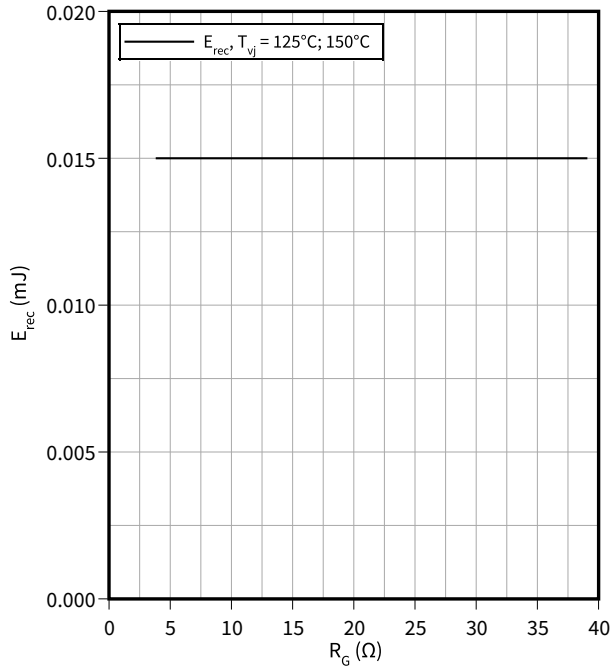
$R_{Gon} = 3.9 \Omega$ ,  $V_{CE} = 300 V$



7 Characteristics diagrams

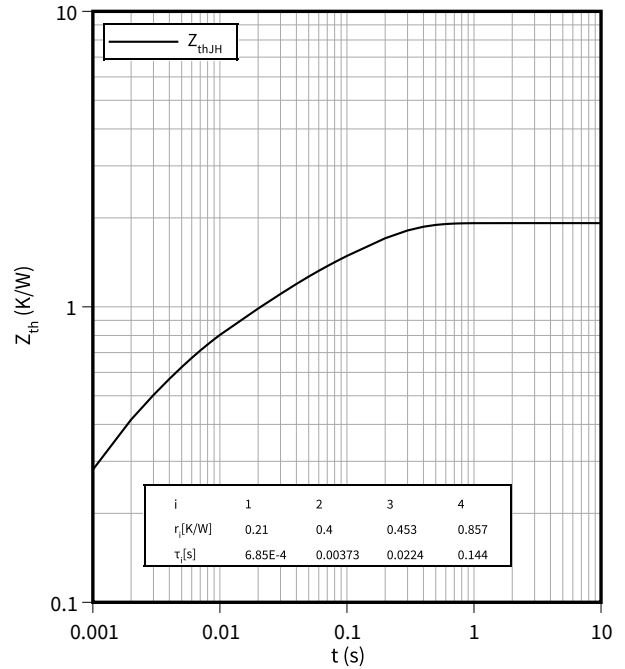
**Switching losses (typical), Diode, 3-Level**

$E_{rec} = f(R_G)$   
 $V_{CE} = 300\text{ V}, I_F = 20\text{ A}$



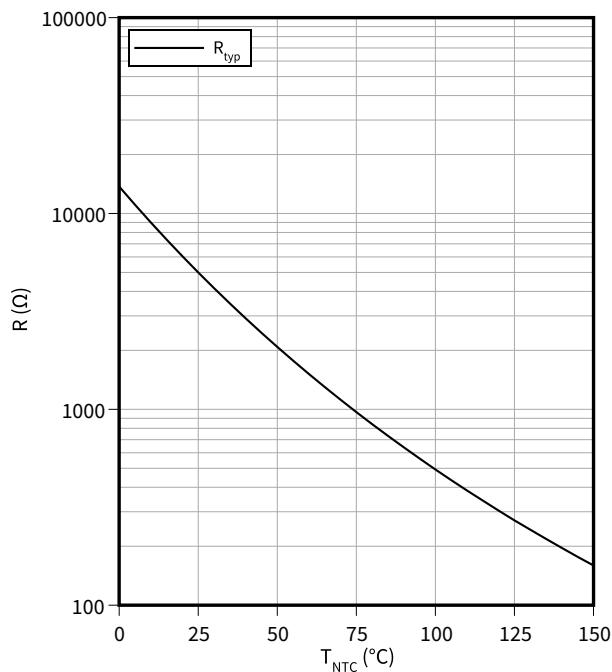
**Transient thermal impedance, Diode, 3-Level**

$Z_{th} = f(t)$



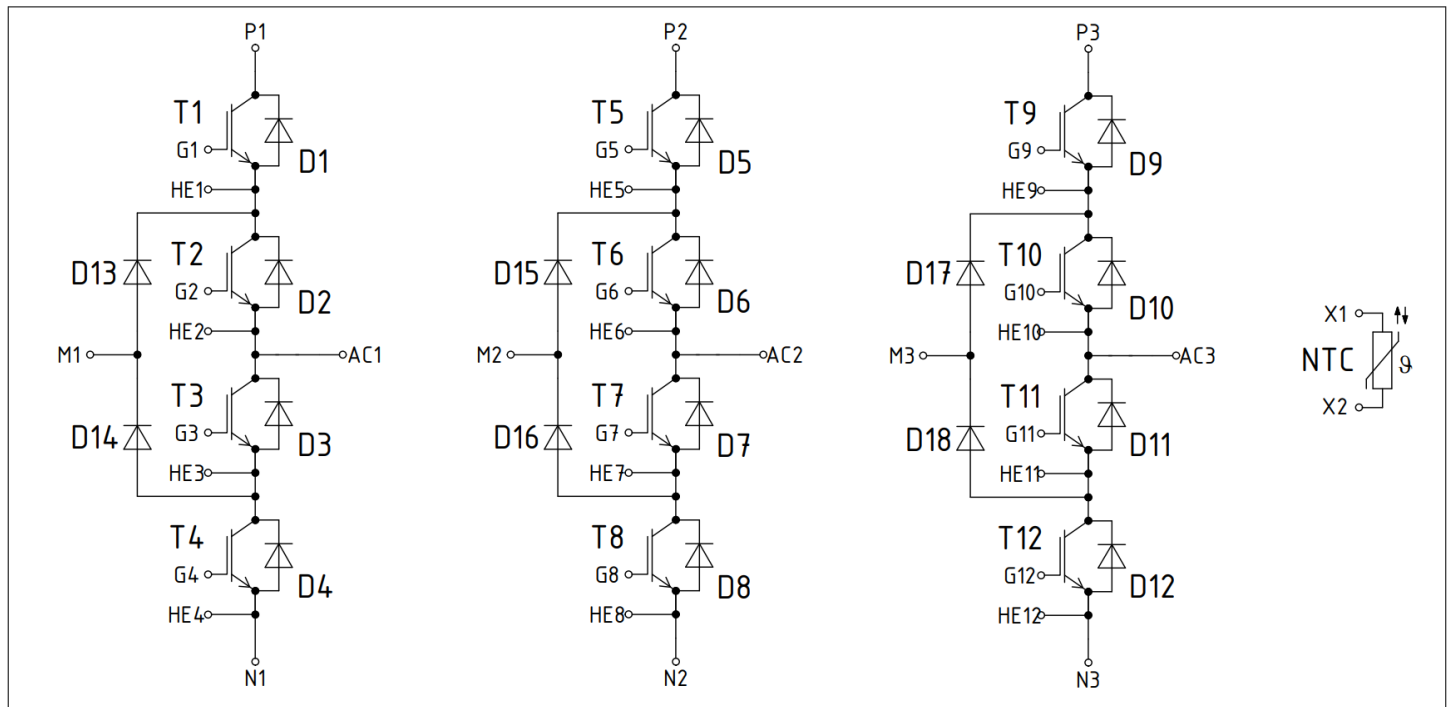
**Temperature characteristic (typical), NTC-Thermistor**

$R = f(T_{NTC})$



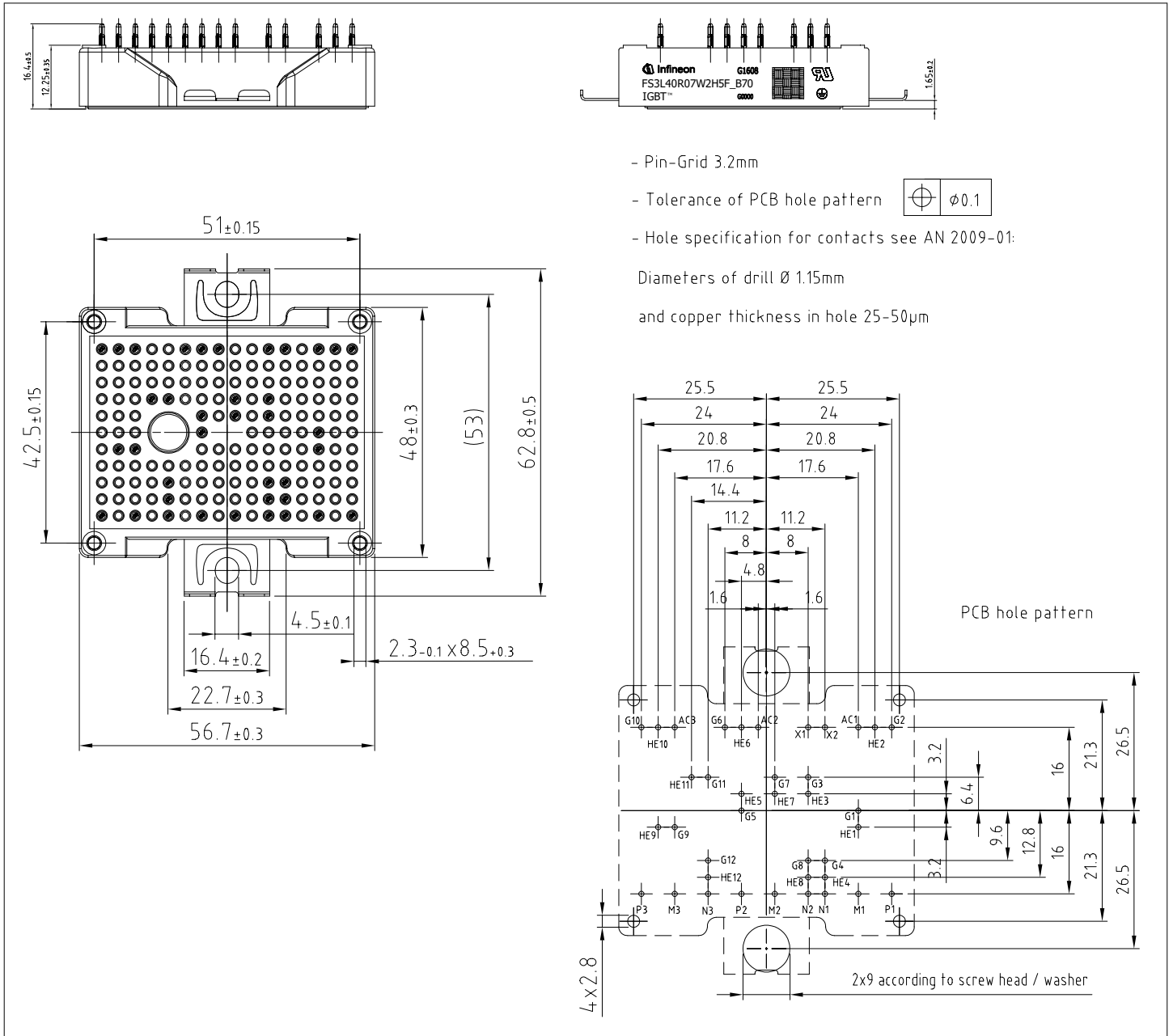


## 8 Circuit diagram




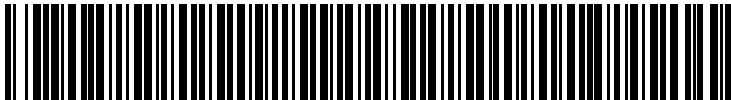
**Figure 1**

**9 Package outlines**



**Figure 2**

## 10 Module label code

Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	Content	Digit	Example
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

**Figure 3**

## Revision history

Document revision	Date of release	Description of changes
0.10	2023-10-04	Initial version
1.00	2024-04-09	Final datasheet

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**Document reference**

**IFX-ABH459-002**

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[FP15R12YT3](#) [FP20R06W1E3](#) [FP30R06W1E3](#) [FP40R12KT3G](#) [FP75R06KE3](#) [FS10R12YE3](#) [FS150R07PE4](#) [FS150R12PT4](#)  
[FS150R17N3E4\\_B11](#) [FS20R06W1E3\\_B11](#) [FS30R06W1E3\\_B11](#) [FS75R12KE3G](#) [FS75R12W2T4\\_B11](#) [FZ1600R17HP4\\_B2](#)  
[FZ300R12KE3G](#) [FZ400R17KE3](#) [FZ400R17KE4](#) [FZ600R65KE3](#) [DF1000R17IE4D\\_B2](#) [APTGT75DA60T1G](#) [DZ800S17K3](#) [F12-](#)  
[25R12KT4G](#) [F3L200R12W2H3\\_B11](#) [F3L300R12ME4\\_B22](#) [F3L75R07W2E3\\_B11](#) [F4-150R12KS4](#) [F475R07W1H3B11ABOMA1](#)  
[FD1400R12IP4D](#) [FD400R12KE3\\_B5](#)